

-20V P-CHANNEL MOSFET

Features

- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- Motor control and drive
- Battery management
- UPS (Uninterrupible Power Supplies)

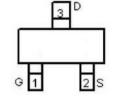
Product Summary

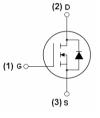


V ds	-20	V
R DS(on), TYP@ VGS=-4.5 V	32	mΩ
/ D	-4.1	А



SOT-23





N-Channel

Absolute Maximum Ratings (T_A=25℃unless otherwise noted)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage		Vds	-20	V
Gate-Source Voltage		Vgs	±12	V
Continuous Drain Current	T _C =25℃		-4.1	A
	T _C =70 ℃		-3.2	
	T _A =25℃		-3	
	T _A =70℃		-2.3	
Drain Current -Pulsed (Note 1)		I _{DM}	-15	А
Maximum Power Dissipation		PD	1.7	W
Operating Junction and Storage Temperature Range		TJ,TSTG	-55 To 150	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	R _{0JA}	74	°C/W
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Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit	
Off Characteristics	·					•	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA	-20	-	-	V	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V,V _{GS} =0V	-	-	-1	μA	
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±12V,V _{DS} =0V	-	-	±100	nA	
On Characteristics (Note 3)	ł			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-0.45	-0.7	-1.0	V	
		V _{GS} =-4.5V, I _D =-4.1A	-	32	42	+	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-2.5V, I _D =-3A	-	50	75	mΩ	
Forward Transconductance	G FS	V _{DS} =-5V,I _D =-2A	6	-	-	S	
Dynamic Characteristics (Note4)				•			
Input Capacitance	C _{lss}		-	740	-	PF	
Output Capacitance	C _{oss}	V_{DS} =-4V, V_{GS} =0V,	-	290	-	PF	
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	190	-	PF	
Switching Characteristics (Note 4)	·					•	
Turn-on Delay Time	t _{d(on)}		-	12	-	nS	
Turn-on Rise Time	tr	V _{DD} =-4V,I _D =-3.3A ,	-	35	-	nS	
Turn-Off Delay Time	t _{d(off)}	R_{L} =-1.2Ω, V_{GEN} =-4.5V, R_{g} =1Ω	-	30	-	nS	
Turn-Off Fall Time	t _f	-	-	10	-	nS	
Total Gate Charge	Qg		-	7.8	-	nC	
Gate-Source Charge	Q _{gs}	V _{DS} =-4V,I _D =-4.1A,V _{GS} =-4.5V	-	1.2	-	nC	
Gate-Drain Charge	Q _{gd}		-	1.6	-	nC	
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-1.6A	-	-	-1.2	V	
Diode Forward Current (Note 2)	Is		-	-	1.6	Α	

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.

4. Guaranteed by design, not subject to production



ASDM3415ZA -20V P-CHANNEL MOSFET

t_{d(off)}

INVERTED

PULSE WIDTH

Figure 2:Switching Waveforms

90%

109

90%

50%

on

10%

50%

90%

t_{d(on)}

Vout

 \mathbf{V}_{IN}

10%

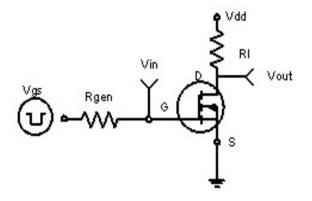
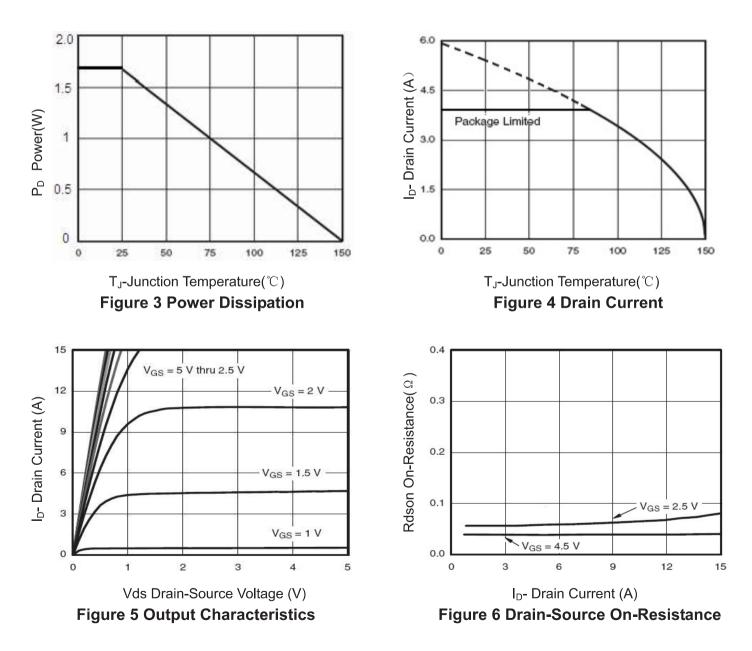
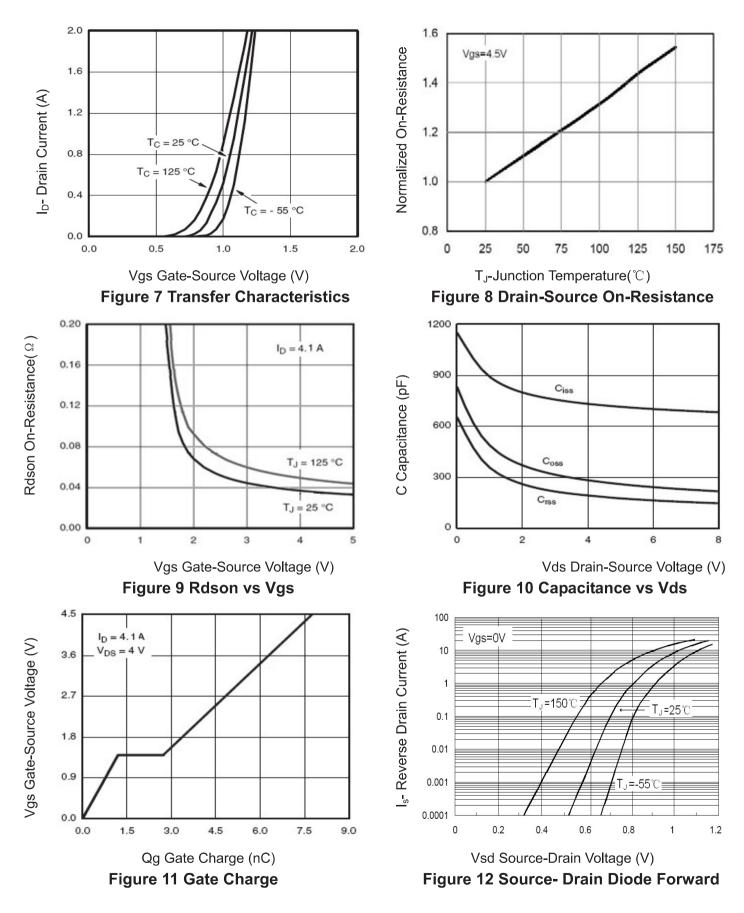


Figure 1:Switching Test Circuit





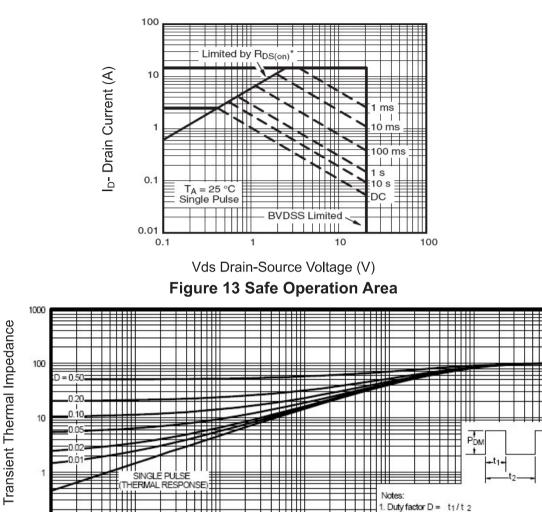
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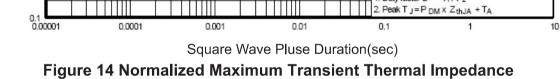




r(t),Normalized Effective

ASDM3415ZA **=20V P-CHANNEL MOSFET**





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Notes:

1. Duty factor D = t1/t 2



Ordering and Marking Information

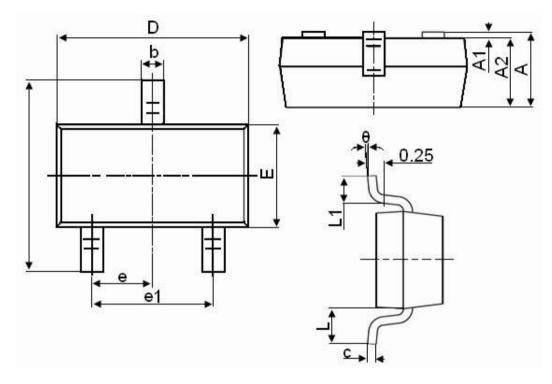
Ordering Device No.	Marking	Package	Packing	Quantity
ASDM3415ZA-R	3415	SOT23	Tape&Reel	3000/Reel

PACKAGE	MARKING
SOT23	3415



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SOT-23 Package Information



Sympol	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
A	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
с	0.080	0.150		
D	2.800	3.000		
E	1.200	1.400		
E1	2.250	2.550		
e		0.950TYP		
e1	1.800	2.000		
L		0.550REF		
L1	0.300	0.500		
θ	0°	8°		

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ± 0.10 mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- 5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.



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